



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Rich Fogal and Michael B. Ball

Serial No.: 09/422,887

Filed: October 21, 1999

For: ANGULARLY OFFSET STACKED DIE
MULTICHIP DEVICE AND METHOD OF
MANUFACTURE

§
§ Group Art Unit: 2822
§
§ Examiner: J. Brophy
§
§ Atty. Docket: 95-0134.05
§
§
§
§

AMENDMENT AND RESPONSE AFTER THE
BOARD DECISION DATED FEBRUARY 10, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Certificate of Mailing (37 C.F.R. § 1.8)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date below:

4/12/04
Date

Susan Jerome
Signature

Applicants herein respond to the Board decision dated February 10, 2004. Please amend the above-captioned application as follows.